

(19) World Intellectual Property  
Organization  
International Bureau



(43) International Publication Date  
23 September 2004 (23.09.2004)

PCT

(10) International Publication Number  
**WO 2004/081079 A1**

- (51) International Patent Classification<sup>7</sup>: **C08G 61/08**, H01B 3/30, H05K 1/03
- (21) International Application Number:  
PCT/GB2004/001097
- (22) International Filing Date: 15 March 2004 (15.03.2004)
- (25) Filing Language: English
- (26) Publication Language: English
- (30) Priority Data:  
0305752.8 13 March 2003 (13.03.2003) GB
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- (81) Designated States (*unless otherwise indicated, for every kind of national protection available*): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.
- (84) Designated States (*unless otherwise indicated, for every kind of regional protection available*): ARIPO (BW, GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- Declaration under Rule 4.17:**  
— *of inventorship (Rule 4.17(iv)) for US only*
- Published:**  
— *with international search report*  
— *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments*
- For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.*

(54) Title: CURABLE DIELECTRIC POLYNORBORNENE COMPOSITION AND CIRCUIT BOARDS MADE THEREFROM

(57) Abstract: The present invention relates to a curable dielectric composition comprising polynorbornene, a polymeric diluent that plasticises the composition, a particulate material and a curing agent for the composition. The present invention also relates to a cured form of the curable composition and an electronic circuit board including a cured form of the composition upon which is mounted an electronic circuit.



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